

500mW High Speed SMD Switching Diode

FEATURES

- Designed for mounting on small surface
- Extremely thin/leadless package
- High mounting capability, strong surage with stand, high reliability
- Pb free and RoHS compliant
- Halogen free

MECHANICAL DATA

- Case: 0805 (Ceramics)

- High temperature soldering guaranteed: 260°C/10s

- Polarity: Indicated by white cathode band

- Weight: 0.006g (approximately)



0805 (Ceramics)







MAXIMUM RATINGS AND ELECTRICAL CHARACTERSTICS (T _A =25°C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Power dissipation	P _D	500	mW		
Non-repetitive peak reverse voltage	V _{RSM}	100	V		
Repetitive peak reverse voltage	V_{RRM}	75	V		
Repetitive peak forward current	I _{FRM}	300	mA		
Mean forward current	I _O	150	mA		
Non-repetitive peak forward surge current Tp = 1s square waveform Tp = 8.3ms single half sine waveform	I _{FSM}	0.5 2.0	A		
Thermal resistance form junction ambient (Note 1)	$R_{\theta JA}$	375	°C/W		
Junction and storage temperature range	T _J , T _{STG}	- 55 to +175	°C		

PARAMET	SYMBOL	MIN	MAX	UNIT	
Reverse breakdown voltage	(Note 2)	$V_{(BR)}$	-	75	V
Forward voltage	I _F =100mA	V _F	-	1	V
Reverse leakage current	V _R =20V	ı	-	25	nA
	V _R =75V	I _R	-	5	μA
Junction capacitance	V _R =0, f=1.0MHz	C _J		4	pF
Reverse recovery time	(Note 3)	t _{rr}		4	ns

Note: 1 Valid provided that electrodes are kept at ambient temperature

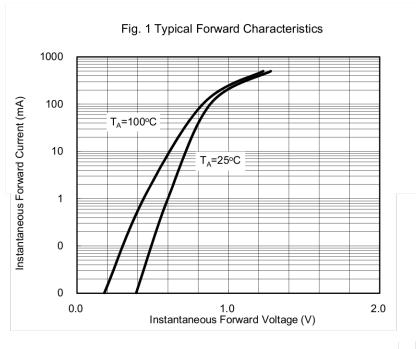
Note: 2 Test Condition: I_R=100µA

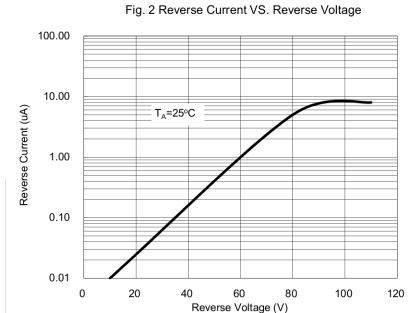
Note: 3 Test Condition: I_F =10mA, I_R =1mA, R_L =100 Ω

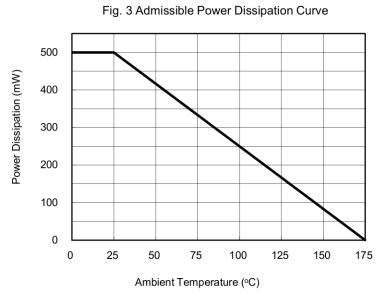


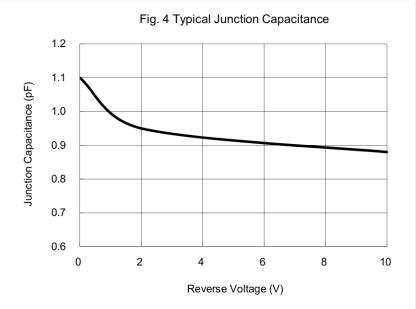
RATINGS AND CHARACTERISTICS CURVES

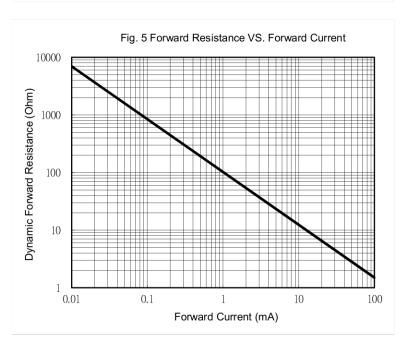
(T_A=25°C unless otherwise noted)











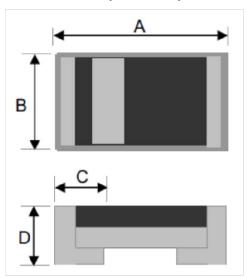


ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
TS4148 RYG	-xx (Note1)	RY RB	G	0805 (Ceramics)	5K / 7" Reel
	(Note1)	KB		(Ceramics)	10K / 13" Reel

Note 1: Part No. Suffix "-xx " would be used for special requirement

EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
TS4148 RYG	TS4148		RY	G	Multiple manufacture source Green compound
TS4148-C0 RYG	TS4148	-C0	RY	G	Defined manufacture source Green compound

PACKAGE OUTLINE DIMENSIONS 0805 (Ceramics)



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	1.80	2.20	0.071	0.087	
В	1.05	1.45	0.041	0.057	
С	0.25	0.65	0.010	0.026	
D	0.75	0.95	0.030	0.037	





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Document Number: DS_S1407005 Version: L14